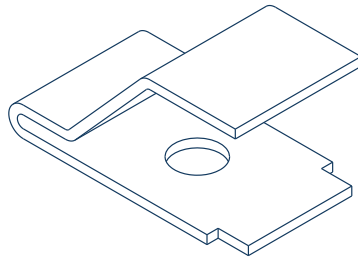




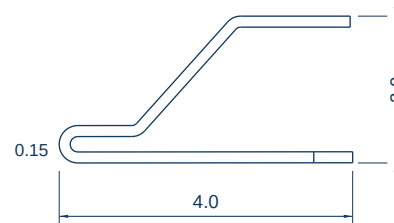
Type 3-05 B305-22040020

SMD EMI Spring Contact | Beryllium Copper | Units: mm

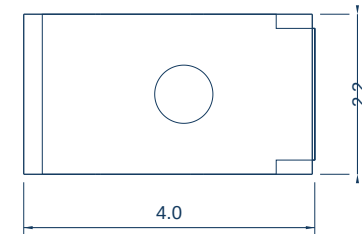
Isometric



Front view (mm)



Top view (mm)



MECHANICAL	VALUE
Thickness	0.15 mm
Width	2.2 mm +/- 0.2
Length	4.0 mm +/- 0.2
Height	2.0 mm +/- 0.2
Form	ramp clip: top plate, sloping web, 180 deg curl, base plate
Bend radii	R0.165 CL, 48 deg R0.165 CL, 48 deg R0.180 CL, 180 deg
Developed length	8.67 mm
Base hole	dia 0.80 mm (from render)
Base plate step	0.53 x 0.195 mm each side at the free end; tongue 1.81 mm wide
Material / plating	BeCu, Gold-plated (G)
Volume / mass	2.754 mm ³ 23.0 mg (BeCu)
File format	STEP AP214

PRODUCT DATA	VALUE
Mfr P/N	B305-22040020G-SY (Au)
Brand	Seyunda
Description	SMD EMI Contact 4.0x2.2x2.0mm Au
Packaging	Tape & Reel (TR)
Category	Connectors, Interconnects
Sub-category	Contacts, Spring Loaded (Pogo Pins), and Pressure
Lifecycle / origin	Active / Taiwan, Republic of China
RoHS / REACH	RoHS3 Compliant / REACH Unaffected
ECCN / ESD	EAR99 / Static sensitive: Yes
Datasheet	seyunda.com/datasheet/Seyunda-SMD-Spring-Contacts-Datasheet.pdf
Product page	seyunda.com/type-3-05.html